

# LNPTM THERMOCOMPTM COMPOUND LF008

LF-1008 REGION AMERICAS

#### DESCRIPTION

LNP THERMOCOMP LF008 compound is based on Polyetheretherketone (PEEK) resin containing 40% glass fiber. Added features of this grade include: High Modulus and Strength.

GENERAL INFORMATION	
Features	High stiffness/Strength, High temperature resistance, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polyetheretherketone (PEEK)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Consumer	Commercial Appliance
Electrical and Electronics	Electronic Components, Mobile Phone - Computer - Tablets
Industrial	Electrical, Material Handling

## **TYPICAL PROPERTY VALUES**

PROPERTIES TYPICAL VALUES UNITS TEST METHODS MECHANICAL<sup>(1)</sup> Tensile Stress, break 154 MPa ASTM D638 Tensile Strain, yield 2.4 % ASTM D638 Tensile Strain, break 2.4 % ASTM D638 Tensile Modulus, 5 mm/min 13780 MPa ASTM D638 Flexural Stress 234 MPa ASTM D790 ASTM D790 Flexural Modulus 9650 MPa Tensile Stress, yield 156 MPa ISO 527 MPa ISO 527 Tensile Stress, break 155 Tensile Strain, yield 2.2 % ISO 527 Tensile Strain, break 2.4 % ISO 527 Tensile Modulus, 1 mm/min 12810 ISO 527 MPa **Flexural Stress** 240 MPa ISO 178 Flexural Modulus 10400 MPa ISO 178 IMPACT (1) Izod Impact, unnotched, 23°C 811 ASTM D4812 J/m Izod Impact, notched, 23°C 69 J/m ASTM D256 ASTM D3763 Instrumented Dart Impact Energy @ peak, 23°C 13 I. Multiaxial Impact 3 ISO 6603 I Izod Impact, unnotched 80\*10\*4 +23°C 53 kJ/m² ISO 180/1U ISO 180/1A Izod Impact, notched 80\*10\*4 +23°C 7 kJ/m²

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# CHEMISTRY THAT MATTERS

Revision 20231109



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
THERMAL <sup>(1)</sup>			
CTE, -40°C to 40°C, flow	1.74E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, xflow	4.18E-05	1/°C	ASTM E831
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	261	°C	ISO 75/Af
PHYSICAL <sup>(1)</sup>			
Density	1.61	g/cm <sup>3</sup>	ASTM D792
Mold Shrinkage, flow, 24 hrs <sup>(2)</sup>	0.5 – 0.7	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs <sup>(2)</sup>	1 – 3	%	ASTM D955
Mold Shrinkage, flow, 24 hrs <sup>(2)</sup>	0.64	%	ISO 294
Mold Shrinkage, xflow, 24 hrs <sup>(2)</sup>	1.1	%	ISO 294
Density	1.61	g/cm <sup>3</sup>	ISO 1183
INJECTION MOLDING (3)			
Drying Temperature	150	°C	
Drying Time	4 - 6	Hrs	
Front - Zone 3 Temperature	380 – 400	°C	
Middle - Zone 2 Temperature	380 – 400	°C	
Rear - Zone 1 Temperature	370 – 380	°C	
Mold Temperature	175 – 190	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	60 – 100	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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